

Model No.:	FYLS-1206GIRAC-RM
Date / Rev.	2024.01.23 / A

# PRODUCT SPECIFICATION

Model No.: FYLS-1206GIRAC-RM

### Features:

■SMD Type

■ Size (mm):3.20\*1.60\*1.95 ■ Emitting Color: Infrared.

Lens Color: Water clear.

**■SMT** package

■ Suitable for all SMT assembly and soldering method

■Pb-free Reflow soldering application

■ RoHS Compliant

MSL:4

# **Applications:**

Mouse

■Optoelectronic switch

Copiers

Scanners

Amusement machines

Surveillance system

Wireless communication









CUSTOMER APPROVED SIGNATURES	APPROVED BY	SALES BY	PREPARED BY
		Foryard S020 2024. 01. 23	Foryard E001 1014, 01, 23

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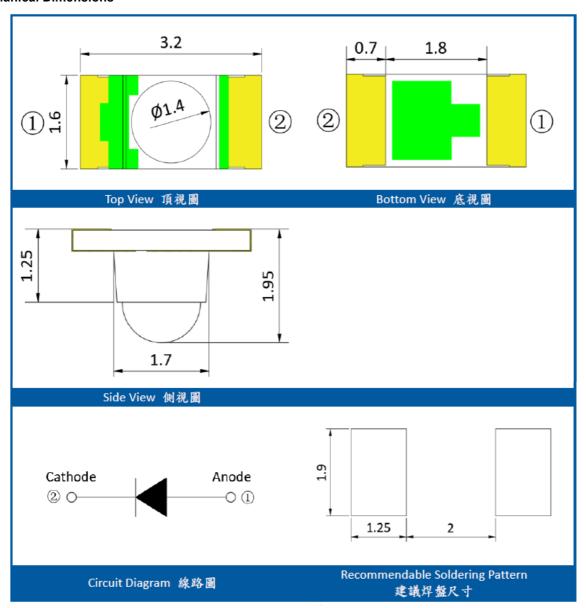
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Http://www.forvard.com Page: 1/8



Model No.:	FYLS-1206GIRAC-RM
Date / Rev.	2024.01.23 / A

#### ■ Mechanical Dimensions



### Notes:

- 1. Dimension in millimeter, tolerance is  $\pm 0.10$ .
- 2.Angle:±5°
- 3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
- 4. The drawing is different from the actual one, please refer to the sample.



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# ■ Absolute Maximun Ratings(Ta=25°C)

Parameter	Symbol	MAX.	Unit
Forward Current	I <sub>F</sub>	100	mA
Pulse Forward Current*	I <sub>FP</sub>	250	mA
Power Dissipation	P <sub>D</sub>	130	Mw
Reverse Voltage	VR	7	V
Operating Temperature Range	Topr	-40~ +85	$^{\circ}\mathbb{C}$
Storage Temperature Range	Tstg	-40~ +100	$^{\circ}$
Soldering Temperature	Tsol	Reflow soldering	: 260°C , 10s

<sup>\*</sup>Pulse 1/10 duty and 0.1 msec

# ■ Typical Electrical &Optical Charcteristics(Ta=25°C)

	,	,				
Parameter	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Radiant Intensity	le	IF=20mA	17	20		mW/sr
Peak Wavelength	λр	IF=20mA		940		nm
Forward Voltage	V <sub>F</sub>	IF=20mA	<b>n</b> 1	1.3	1.5	V
Reverse Current	$I_R$	VR=5V			5	μΑ
Spectral Line Half Width	Δλ	IF=20mA		30		nm
Viewing Angle	2θ <sub>1/2</sub>	IF=20mA		30		Deg

#### Note:

- 1.Luminous Intensity is based on the Foryard standards.
- 2.Pay attention about static for InGaN

# ■Bin Range of Radiant Intensity(Unit: mW/Sr); Test Condition: If=20mA, Ta=25°C

Code	EE1	EE2	EE3	EE4	EE5	EE6
Radiant Intensity(mW/Sr)	17~20	20~23	23~26	26~29	29~32	32~35

Tolerance of Luminous i ntensity: ± 10%

### ■Forward Voltage Grade of Products (Unit: V); Test Condition: If=20mA,Ta=25℃

Code	VE1	VE2	VE3	VE4	VE5
Forward Voltage(V)	1.0~1.1	1.1~1.2	1.2~1.3	1.3~1.4	1.4~1.5

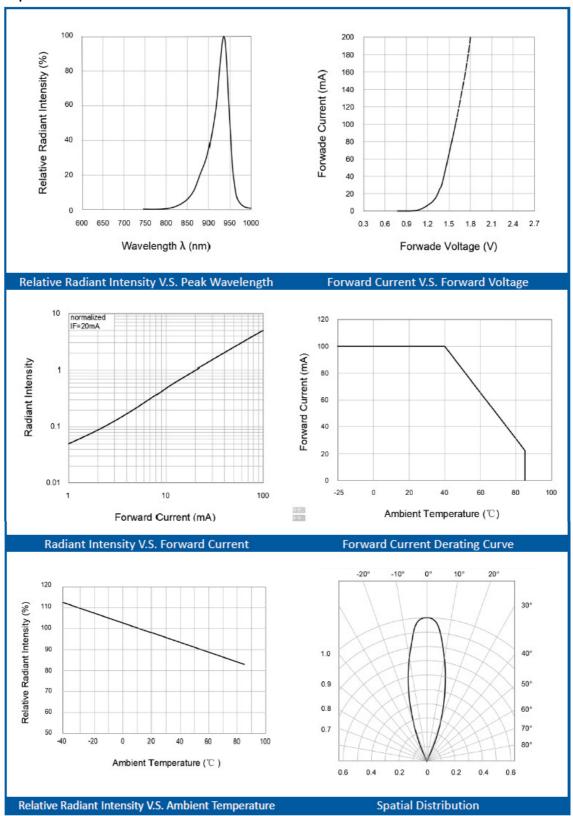
Note: Tolerance of Forward Voltage: ±0.05V.

Http://www.foryard.com Page: 3/8



Model No.:	FYLS-1206GIRAC-RM
Date / Rev.	2024.01.23 / A

### ■ Electrical-Optical Characteristics-



NOTE:25°C free air temperature unless otherwise specified

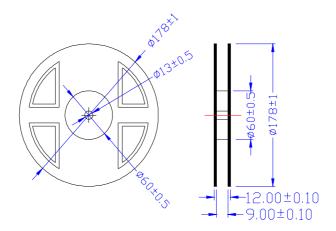
Http://www.foryard.com Page: 4/8



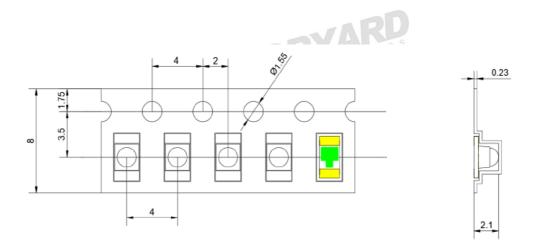
Model No.:	FYLS-1206GIRAC-RM
Date / Rev.	2024.01.23 / A

# ■ Package-

1. Reel Dimension



# 2. Tape Dimension



# Notice:

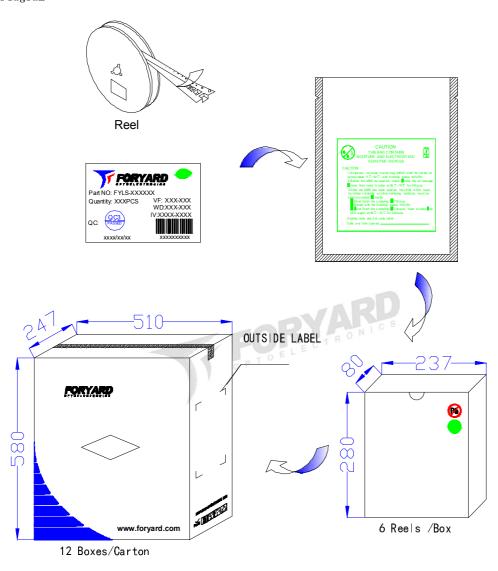
1. Tolerance unless mentioned is  $\pm 0.2 \text{mm}$ 

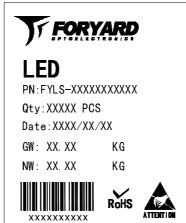
Http://www.foryard.com Page: 5/8



Model No.:	FYLS-1206GIRAC-RM
Date / Rev.	2024.01.23 / A

3. Packing Diagram





OUTSIDE LABEL

### Notice:

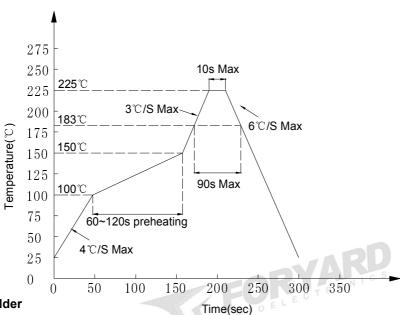
- 1.Quantity:2000 PCS/Reel
- 2. The specifications are subject to change without notice. Please contact us for updated information.

Http://www.foryard.com Page: 6/8

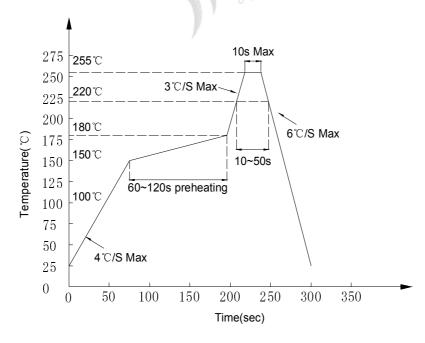


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Date / Rev.	2024.01.23 / A

- Soldering Characteristics-
- Reflow Soldering
- Lead Solder



• Lead-free Solder



#### Notes:

- 1.Although the recommended soldering conditions are specified in above table, reflow or hand soldering at the lowest possible temperature is desired for the LEDs.
- 2.A rapid-rate process is not recommended for cooling the LEDs down from the peak temperature.
- 3.All temperatures refer to solder Pad.

### Hand Soldering

Soldering temperature	300℃ Max. (25W Max.)	One time olny
Soldering time	3 ±1sec	One time only

Http://www.foryard.com Page: 7/8



Mode	l No.:	FYLS-1206GIRAC-RM
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#### ■ Handling of Silicone Resin LEDs-

#### Handling Indications

When handling the product, do not touch it directly with bare hands as it may contaminate the surface and affect on optica characteristics. In the worst cases, excessive force to the product might result in catastrophic failure due to package damage and/or wire breakage.



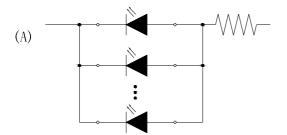
When handling the product with tweezers,LEDs should only be handled from the side and make sure that excessive force is not applied to the resin portion of the pordct. Failure to comply can cause the resin portion of the product to be cut,chipped,delaminated and/or deformed, and wire to be broken, and thus resulting in catastrophic failure.

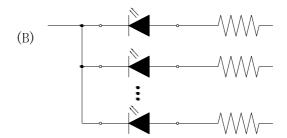




#### ■ Recommended circuit-

• In designing a circuit, the current through each LED must not exceed the absolute maximum rating specified for each LED. It is recommended to use Circuit B which regulates the current flowing through each LED. In the meanwhile, when driving LE with a constant voltage in Circuit A, the current through the LEDs may vary due to the variation in forward voltage(VF) of the LEDs. In the worst case, some LED may be subjected to stresses in excess of the absolute maximum rating.





• This product should be operated in forward bias. A driving circuit must be designed so that the product is not subjected to either forward or reverse voltage while it is off. In particular, if a reverse voltage is continuously applied to the product; such operation can cause migration resulting in LED damage.

#### ■ Storage-

- Storage Conditions
- 1.Unopened moisture barrier bag (MBB) shall be stored at temperature below 5℃~30℃, with humidity below 60%RH.
- 2.Before the MBB be opened, check if have the air leakage, if have, then need to bake at 65 ℃ ~70 ℃ for 24hours.
- 3.After the MBB has been opened, the LEDs which need for reflow soldering or other soldering methods, must be used according to below:
  - a: Must finish the soldering in 72hours
  - b: Stored with the humidity below 30%RH
  - c: If not finish the soldering in 72hours, need to bake the LED again at 65 °C~70 °C for 24hours